



Product Change Notification

112353 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112353 - 00
Change Title: Intel® Server System R1304BB4DC
PCN 112353-00, Product Design
Update System Rear Panel
Date of Publication: June 14, 2013

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jul 04, 2013
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Description of Change to the Customer:

Intel has implemented the following changes on Intel® Server System R1304BB4DC:

1. Add a small cut-out to the system rear panel to provide better clearance for latches on network cables plugging into the Dual Port Intel® X540 10GbE I/O Module AXX10GBTWLIOM.
2. Update the system rear panel so that more PCIe devices and cable connectors (e.g. SFP+ PCIe card) can mechanically fit into the system.

Customer Impact of Change and Recommended Action:

Intel recommends that the customer perform a standard level of evaluation as updated product become available.

Products Affected / Intel Ordering Codes:

EMEA SKU			
Product Code	MM#	Pre Change TA	Post Change TA
R1304BB4DC	918884	G57113-001	G57113-002

PCN Revision History:

Date of Revision: June 14, 2013	Revision Number: 00	Reason: Originally Published PCN
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